

Wiring, Printed - Component

COMPANY

SUNKING CIRCUITS ELECTRONICS CO LTD


Xinle Industry City
 Maan Town
 Huizhou, Guangdong 516257 China

E326765

Type	Cond Width		Min Edge	Cond Thk	SS/ DS	Area Diam	Max Report date After	Surface Mount	Assembly Solder Process	Solder Limits	Max Oper Temp	Meets C UL796	Class	DSR	I
	mm	mm													
Multilayer printed wiring boards															
SK-02	0.1	0.28	17	DS	25.4	No	-	-	-	260	20	130	V-0	All	0
SK-06	0.1	0.1	12	DS	76.2	No	-	-	-	288	20	130	V-0	All	*
SK-08 (ASP 1)	0.075	0.075	12	DS	76.2	Yes	Yes	260	4	-	-	130	V-0	All	*
Single Layer Metal Base Printed Wiring Boards															
SK-03	0.35	0.40	17	SS	25.4	No	-	-	-	288	30	125	V-0	-	-
SK-04 (ASP 1)	0.15	0.15	17	SS	50.8	Yes	Yes	260	2	288	30	130	V-0	All	*
Single layer printed wiring boards															
SK-01	0.1	0.28	17	DS	25.4	No	-	-	-	260	20	130	V-0	All	0
SK-05	0.1	0.1	12	DS	76.2	No	-	-	-	288	20	130	V-0	All	*
SK-07 (ASP 1)	0.075	0.075	12	DS	76.2	Yes	Yes	260	4	-	-	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

(ASP 1) - Assembly Solder process evaluated to IPC-TM-650, 2.6.27B Thermal Stress Assembly Simulation.

Marking: Company name or trademark  or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

Last Updated on 2024-06-04

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